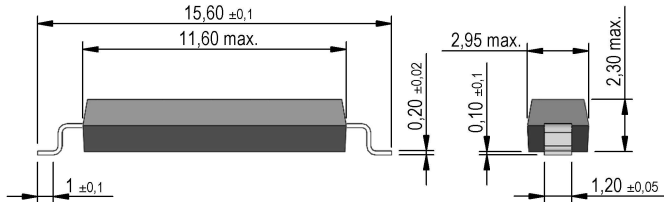


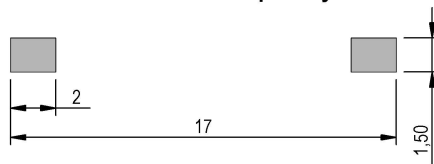
Dimensions mm[inch]

 tolerances acc. to DIN ISO 2768-m
 Toleranzen gem. DIN ISO 2768-m

Isometric

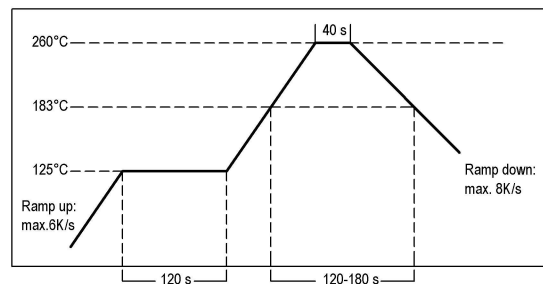
 Scale 2:1
 Maßstab 2:1

Marking

 according to EN60062/factory code
 gem. EN60062/Fertigungsstätte

Recommended pad layout


Reflow soldering conditions acc. to JEDEC norm J-STD-020C



Magnetic properties	Conditions	Min	Typ	Max	Unit
Pull-In	Measured at room temp. 20 ° C overdrive 40%	18		63	AT
Test equipment		KMS11+AP038			

Contact data 35	Conditions	Min	Typ	Max	Unit
Contact - No.		35			
Contact - form		A - NO			
Contact rating	Any DC combination of V & A not to exceed their individual max.'s			20	W
Switching voltage	DC or Peak AC			200	VDC
Switching current	DC or Peak AC			1	A
Carry current	DC or Peak AC			1,25	mA
Contact resistance static	Measured with 40% overdrive Start Value			150	mOhm
Breakdown voltage (>=10AT)	according to IEC 255-5	320			VDC

Special Product Data	Conditions	Min	Typ	Max	Unit
Housing material		mineral-filled epoxy			
Case color		black			

Environmental data	Conditions	Min	Typ	Max	Unit
Shock	1/2 sine, duration 11ms, in 3 axis			50	g
Vibration	from 10 - 2000 Hz			20	g
Operating temperature		-40		130	°C
Storage temperature		-55		130	°C
Washability		fully sealed			
Soldering temperature	wave soldering max. 5 sec.			260	°C

General data	Conditions	Min	Typ	Max	Unit
total length - SMD			15,6		mm